



Winbond Clock Generator
W83195CG-NP
For Intel Napa Platform

Date: Mar/2006 Revision: 0.5



W83195CG-NP Data Sheet Revision History

	Pages	Dates	Version	Web Version	Main Contents
1	n.a.	3/17/2006	0.5	n.a.	All of the versions before 0.50 are for internal use.
2					
3					
4					
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1. GENERAL DESCRIPTION

The W83195CG-NP is a CK410M compliant Clock Synthesizer for Intel P4 processors. W83195CG-NP provides all clocks required for high-speed microprocessor and provides, 8 different frequencies of CPU, PCI, PCI-Express clocks setting. Simultaneously W83195CG-NP supports DOT 96MHz clock outputs for integrated graphic chipsets. All clocks are externally selectable with smooth transitions.

The W83195CG-NP programs the registers to enable or disable each clock outputs through I²C serial bus interface and provides -0.5% spread spectrum or programmable spread spectrum scale to reduce EMI.

The W83195CG-NP is driven with a 14.318 MHz reference crystal and runs on a 3.3V supply.

2. PRODUCT FEATURES

- 2 pair 0.7 V current mode Differential clock outputs for CPU
- 6 pair 0.7V current mode Differential clock outputs for SRC and PCIEX.
- 1 pair 0.7V current mode Differential clock outputs for SATA.
- 1 pair 0.7 V current mode Differential clock outputs select for CPUCLK_ITP/SRC.
- 1 pair 0.7V current mode Differential 96MHz clock outputs for DOT.
- 4 PCI clock outputs for PCI
- 2 PCI clock free running outputs for PCI
- 1 48 MHz clock output for USB.
- 1 14.318MHz REF clock outputs.
- I²C 2-Wire serial interface and support byte read/write and block read/write.
- -0.5% spread spectrum
- Programmable spread spectrum scale to reduce EMI
- Programmable registers to enable/stop each output.
- 56 pin TSSOP package

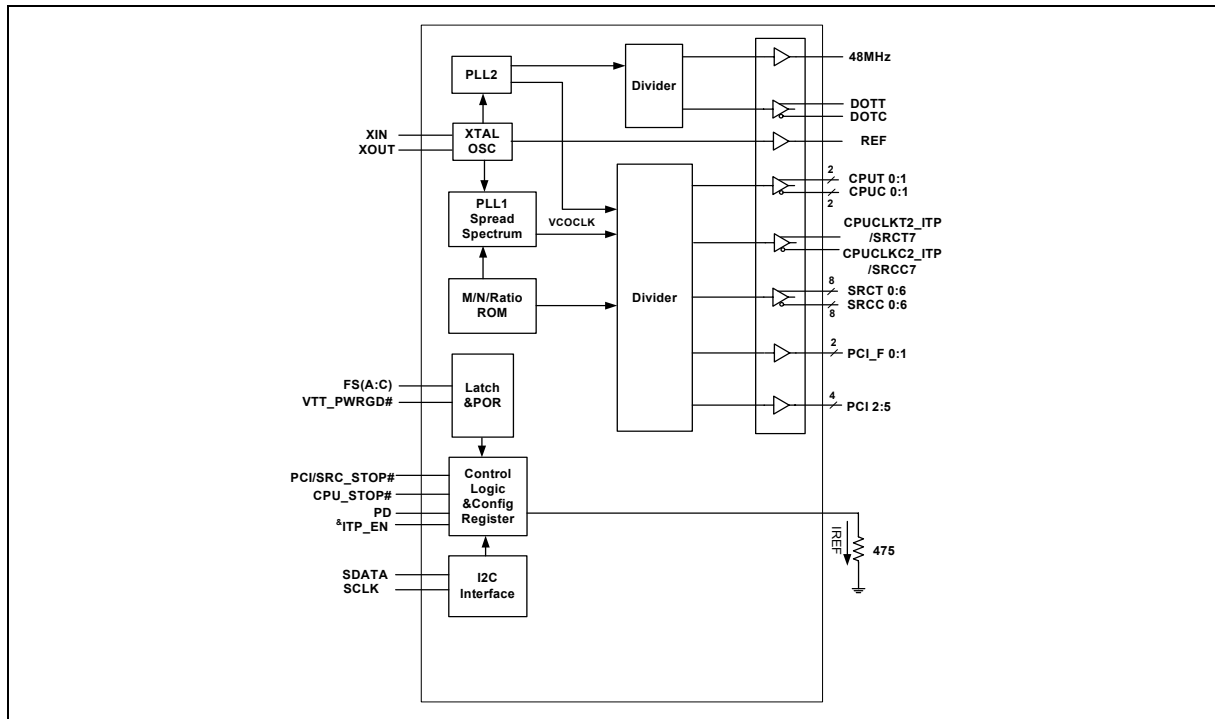


3. PIN CONFIGURATION

VDDPCI	1	56	PCI2
GND	2	55	PCI/SRC_STOP#
PCI3	3	54	CPU_STOP#
PCI4	4	53	⁴ FS_C
PCI5	5	52	REF
GND	6	51	GND
VDDPCI	7	50	X1
⁴ ITP_EN/PCICLK_F0	8	49	X2
PCICLK_F1	9	48	VDDREF
Vtt_PWRG#/PD	10	47	SDATA
VDD48	11	46	SCLK
48MHZ/ ⁴ FS_A	12	45	GND
GND	13	44	CPUCLKT0
DOTT_96MHZ	14	43	CPUCLKC0
DOTC_96MHZ	15	42	VDDCPU
⁴ FS_B	16	41	CPUCLKT1
SRCT0	17	40	CPUCLKC1
SRCC0	18	39	IREF
SRCT1	19	38	GND
SRCC1	20	37	VDDA
VDDSRC	21	36	CPUCLKT2_ITP/SRCT7
SRCT2	22	35	CPUCLKC2_ITP/SRCC7
SRCC2	23	34	VDDSRC
SRCT3	24	33	SRCT6
SRCC3	25	32	SRCC6
SRCT4_SATA	26	31	SRCT5
SRCC4_SATA	27	30	SRCC5
VDDSRC	28	29	GND

#: Active low
 *: Internal pull up resistor 120KΩ to VDD
 &: Internal Pull-down resistor 120KΩ to GND

4. BLOCK DIAGRAM





5. PIN DESCRIPTION

BUFFER TYPE SYMBOL	DESCRIPTION
IN	Input
IN _{tp120k}	Latched input at power up, internal 120kΩ pull up.
IN _{td120k}	Latched input at power up, internal 120kΩ pull down.
OUT	Output
OD	Open Drain
I/OD	Bi-directional Pin, Open Drain.
#	Active Low
*	Internal 120kΩ pull-up
&	Internal 120kΩ pull-down

5.1 Crystal I/O

PIN	PIN NAME	TYPE	DESCRIPTION
50	XIN	IN	Crystal input with internal loading capacitors (18pF) and feedback resistors.
49	XOUT	OUT	Crystal output at 14.318MHz nominally with internal loading capacitors (18pF).

5.2 CPU, SRC, and PCIEX, PCI, Clock Outputs

PIN	PIN NAME	TYPE	DESCRIPTION
44,43,41,40	CPUT [0:1] CPUC [0:1]	OUT	Low skew (< 85ps) 0.7V Current mode differential clock outputs for host frequencies of CPU
17,18,19,20,22,23,24,25,26,27,31,30,33,32	SRCT[0:6] SRCC[0:6]	OUT	0.7V current mode differential clock outputs for SRC. SRC4_SATA is fixed 100MHz for serial ATA.
36,35	SRCT/C 7	OUT	0.7V Current mode differential clock outputs for SRC (default), select by ITP_EN pin =0.
	CPUCLKT/C2_ITP	OUT	0.7V Current mode differential clock outputs for host frequency, select by ITP_EN pin =1.
8	PCI_F0	OUT	3.3V free running PCI clock output.
	&ITP_EN	IN _{td120k}	Latched input for at initial power up to select CPUCLK2_ITP/SRC7 output. 1: CPUCLK2 clock output. 0: SRC7 clock output. This pin has internal 120K pull down.
9	PCI_F1	OUT	3.3V free running PCI clock output.
56,3,4,5	PCI [2:5]	OUT	Low skew (< 250ps) 3.3V PCI clock outputs



5.3 Fixed Frequency Outputs

PIN	PIN NAME	TYPE	DESCRIPTION
52	REF	OUT	3.3V REF 14.318Mhz clock output.
12	48MHz	OUT	48MHz clock output for USB.
	*FSA	IN _{tp120k}	Latched iNOut for FSA at initial power up for H/W selecting the output frequency. Latched voltage level refers to V _{il_FS} and V _{ih_FS} voltage level. This is internal 120K pull up.
14,15	DOTT/C	OUT	0.7V current mode 96MHz differential clock outputs for DOT
16	&FSB	IN _{td120k}	Latched iNOut for FSB at initial power up for H/W selecting the output frequency. Latched voltage level refers to V _{il_FS} and V _{ih_FS} voltage level. This is internal 120K pull down.
53	&FSC	IN _{td120k}	Latched input for FS2 at initial power up for H/W selecting the output frequency. Latched voltage level refers to V _{il_FS} and V _{ih_FS} voltage level. This is internal 120K pull down.

5.4 I2C Control Interface

PIN	PIN NAME	TYPE	DESCRIPTION
47	SDATA	I/O	Serial data of I ² C 2-wire control interface
46	SCLK	IN	Serial clock of I ² C 2-wire control interface

5.5 Power Management Pins

PIN	PIN NAME	TYPE	DESCRIPTION
39	IREF	OUT	Deciding the reference current for the differential pairs. The pin was connected to the precision resistor tied to ground to decide the appropriate current; 475 ohm is the standard value.
54	CPU_STOP#*	IN	CPU clock stop control pin, This pin is low active. Internal 120kΩ pull-up.
55	PCI/SRC_STOP#*	IN	PCI clock stop control pin, This pin is low active. Internal 120kΩ pull-up.
10	VTT_PWRGD#	IN	Power good is a low active input signal used to determine when FS [2:0] are valid to be sample.
	PD	IN _{td120k}	Power Down Function. This is power down pin, high active (PD). Internal 120K pull down



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5.6 Power Pins

PIN	PIN NAME	TYPE	DESCRIPTION
37	VDDA	PWR	3.3V power supply for PLL core.
1,7	VDDP	PWR	3.3V power supply for PCI.
21,28,34	VDDS	PWR	3.3V power supply for SRC pair.
11	VDD48	PWR	3.3V power supply for 48MHz.
42	VDDC	PWR	3.3V power supply for CPU.
48	VDDR	PWR	3.3V power supply for REF.
38	GNDA	PWR	Ground pin for PLL core.
2,6,13,29,45,51	GND	PWR	Ground pin

6. FREQUENCY SELECTION BY HARDWARE

FS4	FS3	FS2	FS1	FS0	CPU (MHZ)	DOT (MHZ)	SRC (MHZ)	PCI (MHZ)
0	0	0	0	0	266.66	96.00	100.00	33.33
0	0	0	0	1	133.33	96.00	100.00	33.33
0	0	0	1	0	200.00	96.00	100.00	33.33
0	0	0	1	1	166.66	96.00	100.00	33.33
0	0	1	0	0	333.33	96.00	100.00	33.33
0	0	1	0	1	100.00	96.00	100.00	33.33
0	0	1	1	0	400.00	96.00	100.00	33.33
0	0	1	1	1	200.00	96.00	100.00	33.33



7. I²C CONTROL AND STATUS REGISTERS

7.1 Register 0: (Default : FFh)

BIT	AFFECTED PIN/ FUNCTION NAME(S)	PWD	AFFECTED PIN / FUNCTION DESCRIPTION	TYPE
7	CPUEN<2>	1	CPUCLK2_ITP/SRCCLK7 output control 1: Enable 0: Disable	R/W
6	SRCEN<6>	1	SRCCLK6 output control 1: Enable 0: Disable	R/W
5	SRCEN<5>	1	SRCCLK5 output control 1: Enable 0: Disable	R/W
4	SRCEN<4>	1	SRCCLK4 output control 1: Enable 0: Disable	R/W
3	SRCEN<3>	1	SRCCLK3 output control 1: Enable 0: Disable	R/W
2	SRCEN<2>	1	SRCCLK2 output control 1: Enable 0: Disable	R/W
1	SRCEN<1>	1	SRCCLK1 output control 1: Enable 0: Disable	R/W
0	SRCEN<0>	1	SRCCLK0 output control 1: Enable 0: Disable	R/W

7.2 Register 1: (Default : FEh)

BIT	AFFECTED PIN/ FUNCTION NAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	PCIFEN<0>	1	PCI_F0 output control 1: Enable 0: Disable	R/W
6	F96EN	1	DOT96_T/C output control 1: Enable 0: Disable	R/W
5	F48EN	1	USB48M output control 1: Enable 0: Disable	R/W


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Register 1: (Default : FEh), continued

BIT	AFFECTED PIN/ FUNCTION NAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
4	REFEN<0>	1	REFOUT output control 1: Enable 0: Disable	R/W
3	Reserved	1	Reserved	R/W
2	CPUEN<1>	1	CPUCLK1 output control 1: Enable 0: Disable	R/W
1	CPUEN<0>	1	CPUCLK0 output control 1: Enable 0: Disable	R/W
0	SPSPEN	0	Enable spread spectrum mode under clock output. 0 = Spread Spectrum mode disable 1 = Spread Spectrum mode enable	R/W



7.3 Register 2: (Default : FFh)

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	PCIEN<5>	1	PCICLK5 output control 1: Enable 0: Disable	R/W
6	PCIEN<4>	1	PCICLK4 output control 1: Enable 0: Disable	R/W
5	PCIEN<3>	1	PCICLK3 output control 1: Enable 0: Disable	R/W
4	PCIEN<2>	1	PCICLK2 output control 1: Enable 0: Disable	R/W
3	Reserved	1	Reserved	R/W
2	Reserved	1	Reserved	R/W
1	Reserved	1	Reserved	R/W
0	PCIFEN<1>	1	PCI_F1 output control 1: Enable 0: Disable	R/W

7.4 Register 3: (Default : 00h)

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	SRC7_STOP	0	PCI_SRC_STOP# for SRC7 control. 1: Stoppable 0:Free-Running	R/W
6	SRC6_STOP	0	PCI_SRC_STOP# for SRC6 control. 1: Stoppable 0:Free-Running	R/W
5	SRC5_STOP	0	PCI_SRC_STOP# for SRC5 control. 1: Stoppable 0:Free-Running	R/W
4	SRC4_STOP	0	PCI_SRC_STOP# for SRC4 control. 1: Stoppable 0:Free-Running	R/W



Register 3: (Default : 00h), continued

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
3	SRC3_STOP	0	PCI_SRC_STOP# for SRC3 control. 1: Stoppable 0:Free-Running	R/W
2	SRC2_STOP	0	PCI_SRC_STOP# for SRC2 control. 1: Stoppable 0:Free-Running	R/W
1	SRC1_STOP	0	PCI_SRC_STOP# for SRC1 control. 1: Stoppable 0:Free-Running	R/W
0	SRC0_STOP	0	PCI_SRC_STOP# for SRC0 control. 1: Stoppable 0:Free-Running	R/W

7.5 Register 4: (Default : 87)

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	Reserved	1	Reserved	R/W
6	Reserved	0	Reserved	R/W
5	Reserved	0	Reserved	R/W
4	PCIF<1>	0	PCI_SRC_STOP# for PCIF1 control. 1: Stoppable 0:Free-Running	R/W
3	PCIF<0>	0	PCI_SRC_STOP# for PCIF0 control. 1: Stoppable 0:Free-Running	R/W
2	CPUCLK2_FS_ITP	1	1: Enable CPUCLK2_ITP stop feature 0: Disable stop feature	R/W
1	CPUCLK1_FS	1	1: Enable CPUCLK1 stop feature 0: Disable stop feature	R/W
0	CPUCLK0_FS	1	1: Enable CPUCLK0 stop feature 0: Disable stop feature	R/W



7.6 Register 5: (Default : 00h)

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	DRI_CONT (Reserved)	0	<p>CPUT / SRCT / PCI_EXP / DOT96_T output state in during POWER DOWN assertion. 1: Driven (2*Iref) 0: Tristate (Floating)</p> <p>CPUT / SRCT / PCI_EXP / DOT96_T output state in during STOP Mode assertion. 1: Driven (6*Iref) 0: Tristate (Floating)</p> <p>Complementary parts always tri-state (floating) in power down or stop mode.</p>	R/W
6	Reserved	0	Reserved	R/W
5	Reserved	0	Reserved	R/W
4	Reserved	0	Reserved	R/W
3	Reserved	0	Reserved	R/W
2	Reserved	0	Reserved	R/W
1	Reserved	0	Reserved	R/W
0	SEL_ITP	0	<p>Power on latched value of ITP_EN/PCICLK_F0 pin. SRCCLK/CPU_ITP output clock selection : 1: CPU_ITP clock output 0: SRCCLK clock output</p>	R/W

7.7 Register 6: (Default : XXh)

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	Reserved	1	Reserved	R/W
6	Reserved	0		
5	Reserved	0		
4	Reserved	0		
3	PCI/SRCCLK_STOP	1	<p>To stop all PCICLK and SRCCLK output 1: Disable 0: Enable</p>	R/W
2	FSC_BACK	X	Power on latched value of FSC pin.	R
1	FSB_BACK	X	Power on latched value of FSB pin.	R
0	FSA_BACK	X	Power on latched value of FSA pin.	R



7.8 Register 7: Winbond Chip ID – Project Code Register (Default : 11h)

BIT	AFFECTED PIN/ FUNCTIONNAME(S)	PWD	FUNCTION DESCRIPTION	TYPE
7	CHPI_ID [7]	0	Winbond Chip ID.	R
6	CHPI_ID [6]	0	Winbond Chip ID.	R
5	CHPI_ID [5]	0	Winbond Chip ID.	R
4	CHPI_ID [4]	1	Winbond Chip ID.	R
3	CHPI_ID [3]	0	Winbond Chip ID.	R
2	CHPI_ID [2]	0	Winbond Chip ID.	R
1	CHPI_ID [1]	0	Winbond Chip ID.	R
0	CHPI_ID [0]	1	Winbond Chip ID.	R

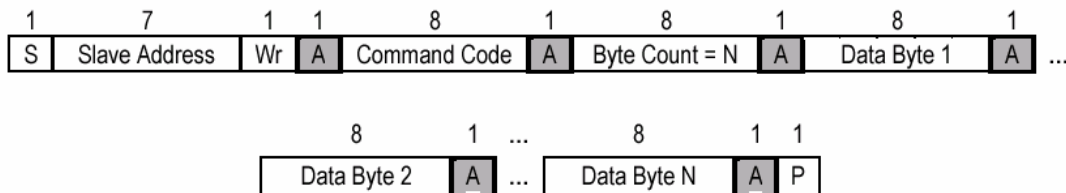


8. ACCESS INTERFACE

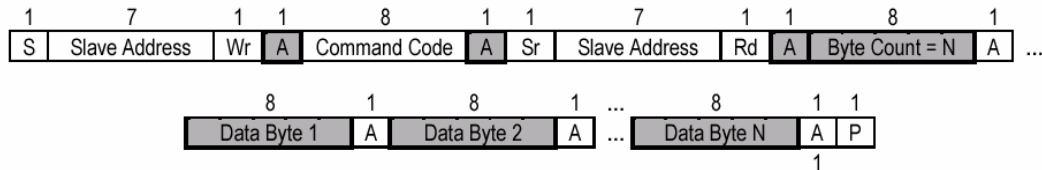
The W83195CG-NP provides I²C Serial Bus for microprocessor to read/write internal registers. In the W83195CG-NP is provided Block Read/Block Write and Byte-Data Read/Write protocol. The I²C address is defined at 0xD2.

Block Read and Block Write Protocol

8.1 Block Write protocol

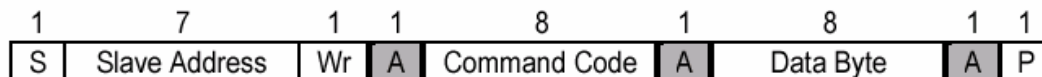


8.2 Block Read protocol

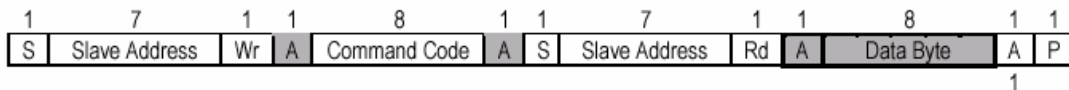


In block mode, the command code must filled 8'h00

8.3 Byte Write protocol



8.4 Byte Read protocol





9. SPECIFICATIONS

9.1 ABSOLUTE MAXIMUM RATINGS

Stresses greater than those listed in this table may cause permanent damage to the device. Precautions should be taken to avoid application of any voltage higher than the maximum rated voltages to this circuit. Subjection to maximum conditions for extended periods may affect reliability. Unused inputs must always be tied to an appropriate logic voltage level (Ground or VDD).

PARAMETER	RATING
Absolute 3.3V Core Supply Voltage	-0.5V to +4.6V
Absolute 3.3V I/O Supply Voltage	- 0.5V to + 4.6V
Operating 3.3V Core Supply Voltage	3.135V to 3.465V
Operating 3.3V I/O Supply Voltage	3.135V to 3.465V
Storage Temperature	- 65°C to + 150°C
Ambient Temperature	- 55°C to + 125°C
Operating Temperature	0°C to + 70°C
Input ESD protection (Human body model)	2000V

9.2 General Operating Characteristics

<i>VDD</i> = 3.3V ± 5 %, <i>TA</i> = 0°C to +70°C,					
Parameter	Symbol	Min	Max	Units	Test Conditions
Input Low Voltage	V_{IL}		0.8	V_{dc}	
Input High Voltage	V_{IH}	2.0		V_{dc}	
Output Low Voltage	V_{OL}		0.4	V_{dc}	
Output High Voltage	V_{OH}	2.4		V_{dc}	
Operating Supply Current	I_{dd}		350	mA	CPU = 100 to 400 MHz PCI = 33.3 Mhz with load 10pF
Input pin capacitance	C_{in}		5	pF	
Output pin capacitance	C_{out}		6	pF	
Input pin inductance	L_{in}		7	nH	



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9.3 Skew Group timing clock

<i>VDD = 3.3V ± 5 %, TA = 0°C to +70°C, Cl=10pF</i>				
Parameter	Min	Max	Units	Test Conditions
CPU pair to CPU pair Skew		100	ps	Measure Crossing point
PCIE pair to PCIE pair Skew		85	ps	Measure Crossing point
PCI to PCI Skew		500	ps	Measured at 1.5V
48MHz to 48MHz Skew		1000	ps	Measured at 1.5V

9.4 CPU 0.7V Electrical Characteristics

<i>VDDC= 3.3V ± 5 %, TA = 0°C to +70°C, Test load Rs=33, Rp=49.9 Cl=2pF, Vol=0.175V, Voh=0.525V, Vr=475, IREF=2.32mA, loh=6*IREF</i>				
Parameter	Min	Max	Units	Test Conditions
Rise Time	175	700	ps	Measure Single Ended waveform
Fall Time	175	700	ps	Measure Single Ended waveform
Absolute crossing point Voltages	250	550	mV	Measure Single Ended waveform
Voltage High	660	850	mV	Measure Single Ended waveform
Voltage Low	-150		mV	Measure Single Ended waveform
Cycle to Cycle jitter		125	ps	Measure Differential waveform
Duty Cycle	45	55	%	Measure Differential waveform

9.5 SRC 0.7V Electrical Characteristics

<i>VDDS= 3.3V ± 5 %, TA = 0°C to +70°C, Test load Rs=33, Rp=49.9 Cl=2pF, Vol=0.175V, Voh=0.525V, Vr=475, IREF=2.32mA, loh=6*IREF</i>				
Parameter	Min	Max	Units	Test Conditions
Rise Time	175	700	ps	Measure Single Ended waveform
Fall Time	175	700	ps	Measure Single Ended waveform
Absolute crossing point Voltages	250	550	mV	Measure Single Ended waveform
Voltage High	660	850	mV	Measure Single Ended waveform
Voltage Low	-150		mV	Measure Single Ended waveform
Cycle to Cycle jitter		85	ps	Measure Differential waveform
Duty Cycle	45	55	%	Measure Differential waveform



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9.6 PCIE 0.7V Electrical Characteristics

VDDPE= 3.3V ± 5 %, TA = 0°C to +70°C, Test load Rs=33, Rp=49.9 Cl=2pF, Vol=0.175V, Voh=0.525V, Vr=475, IREF=2.32mA, loh=6*IREF				
Parameter	Min	Max	Units	Test Conditions
Rise Time	175	700	ps	Measure Single Ended waveform
Fall Time	175	700	ps	Measure Single Ended waveform
Absolute crossing point Voltages	250	550	mV	Measure Single Ended waveform
Voltage High	660	850	mV	Measure Single Ended waveform
Voltage Low	-150		mV	Measure Single Ended waveform
Cycle to Cycle jitter		85	ps	Measure Differential waveform
Duty Cycle	45	55	%	Measure Differential waveform

9.7 PCI Electrical Characteristics

VDDP= 3.3V ± 5 %, TA = 0°C to +70°C, Test load, Cl=10pF,				
Parameter	Min	Max	Units	Test Conditions
Rise Time	500	2000	ps	Vol=0.4V, Voh=2.4V
Fall Time	500	2000	ps	Voh=2.4V, Vol=0.4V
Cycle to Cycle jitter		250	ps	Measured at 1.5V
Duty Cycle	45	55	%	Measured at 1.5V
Pull-Up Current Min	-33		mA	Vout=1.0V
Pull-Up Current Max		-33	mA	Vout=3.135V
Pull-Down Current Min	30		mA	Vout=1.95V
Pull-Down Current Max		38	mA	Vout=0.4V

9.8 48M Electrical Characteristics

VDD48= 3.3V ± 5 %, TA = 0°C to +70°C, Test load, Cl=10pF,				
Parameter	Min	Max	Units	Test Conditions
Rise Time	500	2000	ps	Vol=0.4V, Voh=2.4V
Fall Time	500	2000	ps	Voh=2.4V, Vol=0.4V
Long term jitter		500	ps	Measured at 1.5V
Duty Cycle	45	55	%	Measured at 1.5V
Pull-Up Current Min	-33		mA	Vout=1.0V
Pull-Up Current Max		-33	mA	Vout=3.135V
Pull-Down Current Min	30		mA	Vout=1.95V
Pull-Down Current Max		38	mA	Vout=0.4V



9.9 REF Electrical Characteristics

<i>VDD= 3.3V ± 5 %, TA = 0°C to +70°C, Test load, Cl=10pF,</i>				
Parameter	Min	Max	Units	Test Conditions
Rise Time	500	2000	ps	Vol=0.4V, Voh=2.4V
Fall Time	500	2000	ps	Voh=2.4V, Vol=0.4V
Cycle to Cycle jitter		1000	ps	Measured at 1.5V
Duty Cycle	45	55	%	Measured at 1.5V
Pull-Up Current Min	-29		mA	Vout=1.0V
Pull-Up Current Max		-23	mA	Vout=3.135V
Pull-Down Current Min	29		mA	Vout=1.95V
Pull-Down Current Max		27	mA	Vout=0.4V

9.10 DOT 0.7V Electrical Characteristics

<i>VDD= 3.3V ± 5 %, TA = 0°C to +70°C, Test load Rs=33, Rp=49.9 Cl=2pF, Vol=0.175V, Voh=0.525V, Vr=475, IREF=2.32mA, loh=6*IREF</i>				
Parameter	Min	Max	Units	Test Conditions
Rise Time	175	700	ps	Measure Single Ended waveform
Fall Time	175	700	ps	Measure Single Ended waveform
Absolute crossing point Voltages	250	550	mV	Measure Single Ended waveform
Voltage High	660	850	mV	Measure Single Ended waveform
Voltage Low	-150		mV	Measure Single Ended waveform
Cycle to Cycle jitter		250	ps	Measure Differential waveform
Duty Cycle	45	55	%	Measure Differential waveform

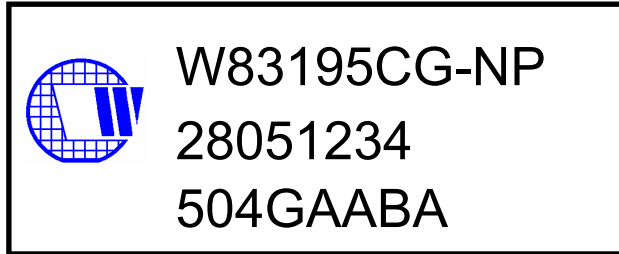
10. ORDERING INFORMATION

PART NUMBER	PACKAGE TYPE	PRODUCTION FLOW
W83195CG-NP	56 PIN TSSOP (Lead free part)	Commercial, 0°C to +70°C

W83195CG-NP



11. HOW TO READ THE TOP MARKING



1st line: Winbond logo and the part number: W83195CG-NP(Lead free)

2nd line: Tracking code 2 8051234

2: wafers manufactured in Winbond FAB 2

8051234: wafer production series lot number

3rd line: Tracking code 504 G A A BA

504: packages made in '2005, week 04

G: assembly house ID; O means OSE, G means GR

A: Internal use code

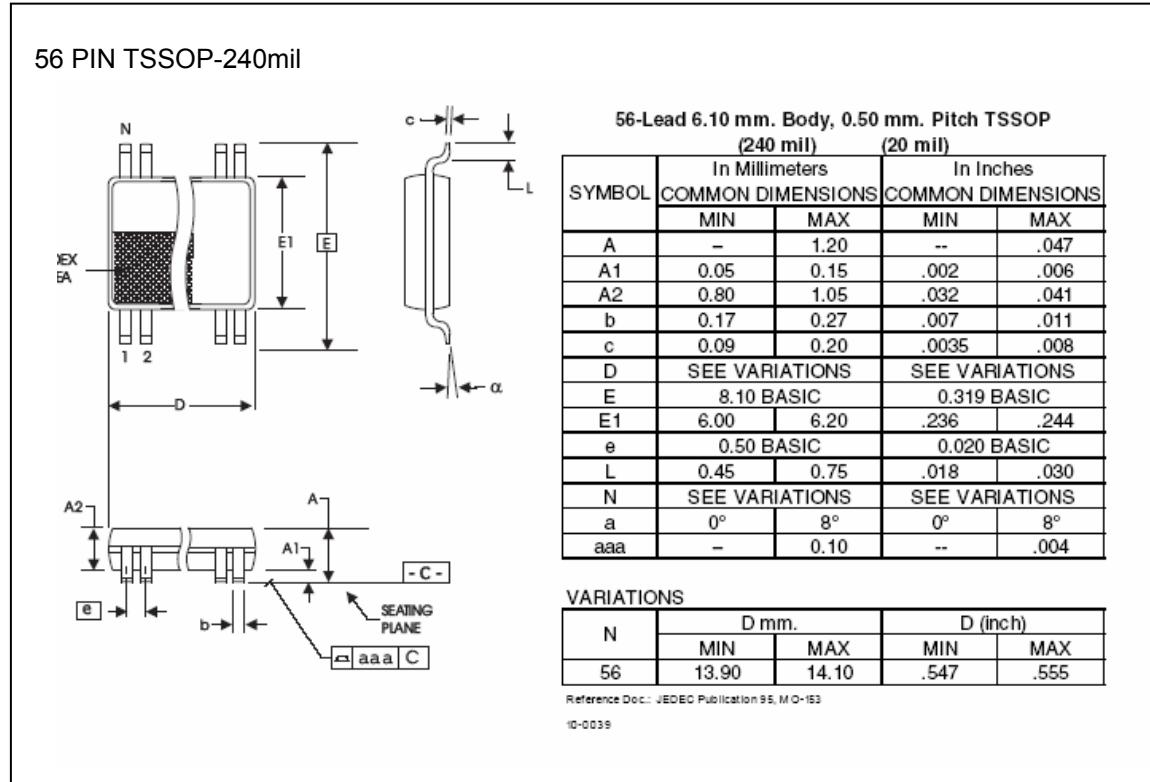
A: IC revision

BA: Internal use code

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12. PACKAGE DRAWING AND DIMENSIONS



W83195CG-NP



Important Notice

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